Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
LED	Forward current	I_F	50	mA
	Forward current derating (Ta ≥ 53°C)	ΔI_F/°C	-0.5	mA/°C
	Peak forward current (100 μs pulse, 100 pps)	I_{FP}	1	A
	Reverse voltage	V_R	5	V
	Diode power dissipation	P_D	50	mW
	Diode power dissipation derating (Ta ≥ 53°C)	ΔP_D /°C	-0.7	mW/°C
	Junction temperature	T_j	125	°C
Detector	Off-state output terminal voltage	V_{OFF}	60	V
	On-state current	I_{ON}	500	mA
	On-state current derating (Ta ≥ 25°C)	ΔI_{ON}/°C	-5.0	mA/°C
	Output power dissipation	P_O	275	mW
	Output power dissipation derating (Ta ≥ 25°C)	ΔP_O / °C	-2.75	mW / °C
	Junction temperature	T_j	125	°C
Storage temperature range		T_{stg}	-55 to 125	°C
Operating temperature range		T_{opr}	-20 to 85	°C
Lead soldering temperature (10 s)		T_{sol}	260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BV_S	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pins1 and 2 shorted together and pins 3 and 4 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Typ.	Max	Unit
Supply voltage	V_{DS}	—	—	48	V
Forward current	I_F	12	20	30	mA
On-state current	I_{ON}	—	—	300	mA
Operating temperature	T_{opr}	-20	—	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	I_F = 10 mA	1.0	1.15	1.3	V
	Reverse current	I_R	V_R = 5 V	—	—	10	μA
	Capacitance	C_T	V = 0 V, f = 1 MHz	—	30	—	pF
Detector	Off-state current	I_{OFF}	V_{OFF} = 60 V	—	—	1	μA
	Capacitance	C_{OFF}	V = 0 V, f = 1 MHz	—	—	—	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	I_{FT}	I_{ON} = 500 mA	—	3	5	mA
On-state resistance	R_{ON}	I_{ON} = 500 mA, I_F = 10 mA	—	0.8	1.1	Ω

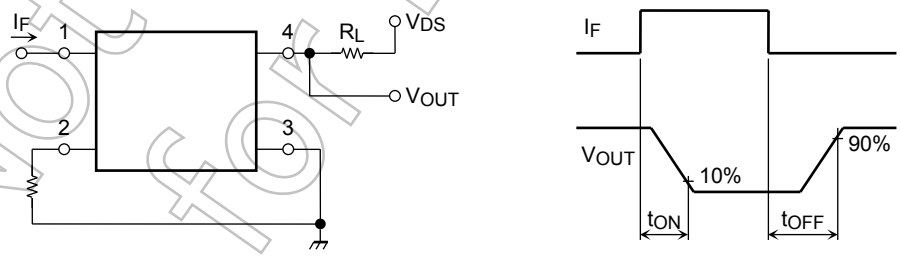
Isolation Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C_S	V_S = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation resistance	R_S	V_S = 500 V, R.H. ≤ 60 %	5×10^{10}	10^{14}	—	Ω
Isolation voltage	BV_S	AC, 60 s	2500	—	—	Vrms

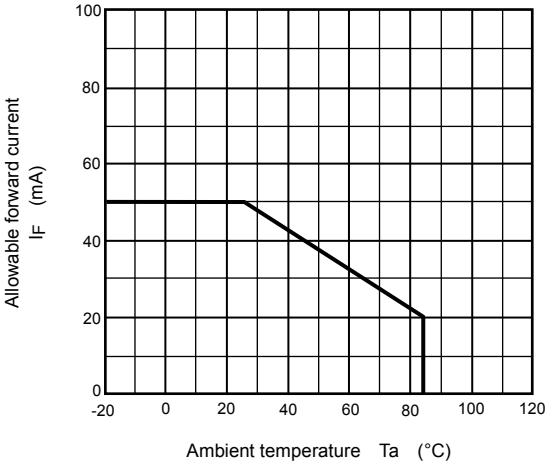
Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t_{ON}	R_L = 200 Ω (Note 2) V_{DS} = 20 V, I_F = 10 mA	—	—	2	ms
Turn-off time	t_{OFF}	R_L = 200 Ω (Note 2) V_{DS} = 20 V, I_F = 10 mA	—	—	2	ms

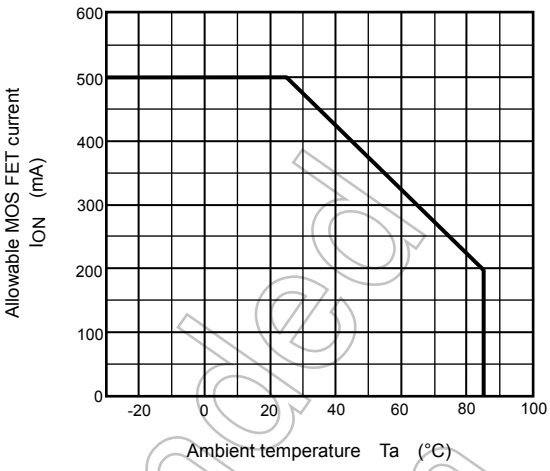
Note 2: Switching time test circuit



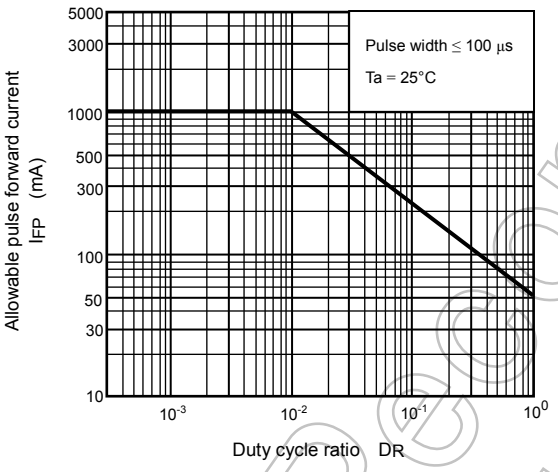
I_F – Ta



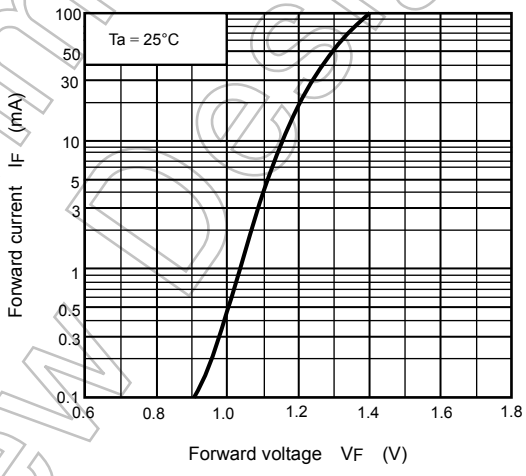
I_{ON} – Ta



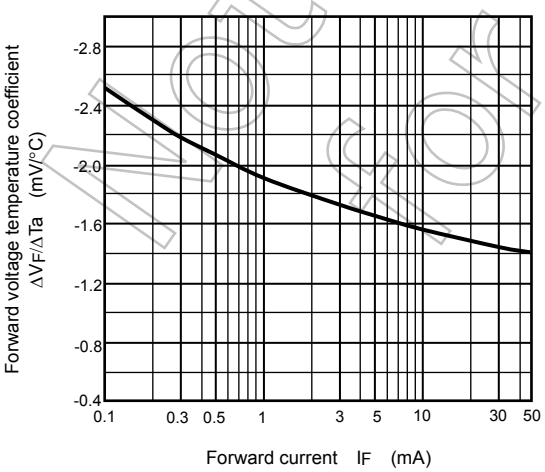
I_{FP} – D_R



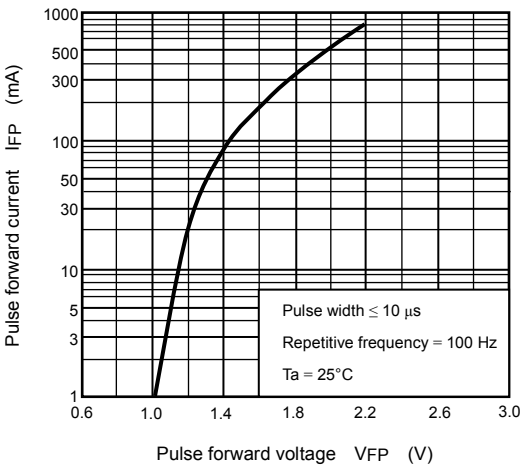
I_F – V_F



$\Delta V_F/\Delta Ta$ – I_F



I_{FP} – V_{FP}



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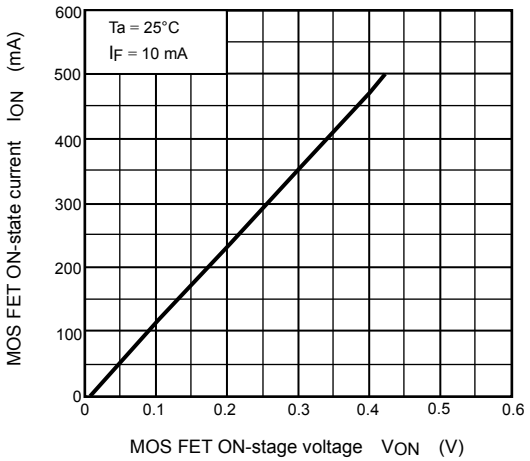
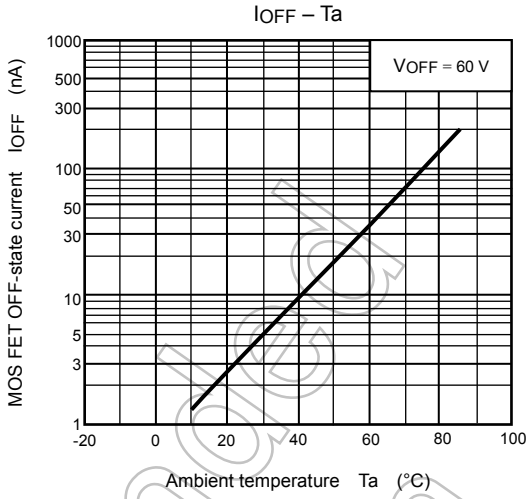
I_{ON} – V_{ON}



I_{OFF} – Ta



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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